Electronic Patent A	\pp	lication Fe	e Transı	mittal		
Application Number:	10	10521287				
Filing Date:	08-Aug-2005					
Title of Invention:	Silicone-based adhesive sheet, method of bonding a semiconductor chip to a chip attachment component, and a semiconductor device					
First Named Inventor/Applicant Name:	Manabu Sutoh					
Filer:	David Michael LaPrairie/Sandra Barry					
Attorney Docket Number:	71,051-001					
Filed as Large Entity						
U.S. National Stage under 35 USC 371 Fill	ing	Fees				
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)	
Basic Filing:						
Pages:						
Claims:						
Miscellaneous-Filing:						
Petition:						
Patent-Appeals-and-Interference:						
Post-Allowance-and-Post-Issuance:						
Extension-of-Time:						
Extension - 1 month with \$0 paid		1251	1	120	120	

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
	Total in USD (\$)			120